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APPLICATION DATA SHEET

Application Information

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

Computer Readable Form (CRF)?:: No

Number of copies of CRF::

Title :: DIELECTRIC PASTE FOR SPACER LAYER OF
A MULTI-LAYERED CERAMIC ELECTRONIC
COMPONENT

Attorney Docket Number:: 890050.543USPC

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure::

Total Drawing Sheets::

Small Entity?:: No

Petition included?:: No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No::

Secrecy Order in Parent Appl.?:: No

First Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
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Middle Name::
Family Name:: Satou
Name Suffix::
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State or Province of Residence::
Country of Residence:: Japan
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Country of mailing address:: Japan
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Second Applicant Information

Applicant Authority Type:: Inventor
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Correspondence InformationCorrespondence Customer Number :: **00500****Representative Information**

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|----------------------------------|--|--------------|
| Representative Customer Number:: | | 00500 |
|----------------------------------|--|--------------|

Domestic Priority Information

| Application :: | Continuity Type:: | Parent Application:: | Parent Filing Date:: |
|------------------|-------------------|----------------------|----------------------|
| This Application | National Stage of | PCT/JP2004/018628 | 12/14/04 |
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| | | | |

Foreign Priority Information

| Country:: | Application number:: | Filing Date:: | Priority Claimed:: |
|-----------|----------------------|---------------|--------------------|
| Japan | 2003-416158 | 12/15/03 | Yes |
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Assignee Information

| | |
|---|-----------------------------|
| Assignee name:: | TDK Corporation |
| Street of mailing address:: | 1-13-1, Nihonbashi, Chuo-ku |
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